



NPN General Purpose Amplifier

This device is for use as a medium power amplifier and switch requiring collector currents up to 500 mA. Sourced from Process 19. See PN2222A for characteristics.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	75	V
V _{EBO}	Emitter-Base Voltage	6.0	V
I _C	Collector Current - Continuous	1.0	Α
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		TN2219A	
P _D	Total Device Dissipation	1.0	W
	Derate above 25°C	8.0	W/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	50	°C/W

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

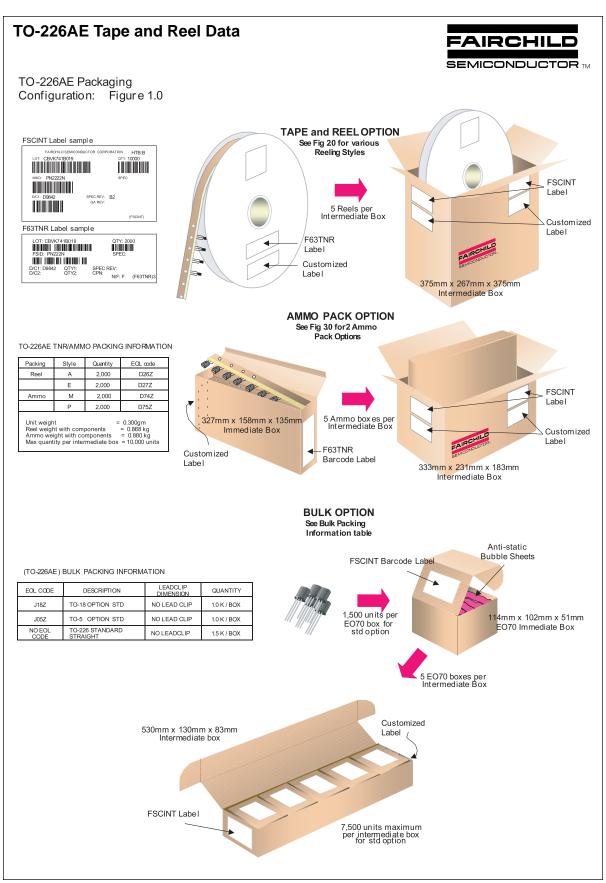
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

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NPN General Purpose Amplifier (continued)

Symbol	Parameter	Test Conditions	Min	Max	Units
OEE CUA	RACTERISTICS				
	Collector-Emitter Breakdown Voltage*	$I_C = 10 \text{ mA}, I_B = 0$	40	ſ	V
V _{(BR)CEO}	Collector-Base Breakdown Voltage	$I_C = 10 \text{ mA}, I_B = 0$ $I_C = 10 \text{ µA}, I_E = 0$	75		V
V _{(BR)CBO}	Emitter-Base Breakdown Voltage	$I_{c} = 10 \mu\text{A}, I_{c} = 0$ $I_{e} = 10 \mu\text{A}, I_{c} = 0$	6.0		V
V _{(BR)EBO}	ŭ		0.0	40	-
I _{CEX}	Collector Cutoff Current	$V_{CE} = 60 \text{ V}, V_{EB(OFF)} = 3.0 \text{ V}$		10	nA
I _{CBO}	Collector Cutoff Current	$V_{CB} = 60 \text{ V}, I_{E} = 0$ $V_{CB} = 60 \text{ V}, I_{E} = 0, T_{A} = 150^{\circ}\text{C}$		10 10	nA μA
I _{EBO}	Emitter Cutoff Current	$V_{CB} = 3.0 \text{ V}, I_{C} = 0$		10	μΛ nA
I _{BL}	Base Cutoff Current	$V_{CE} = 60 \text{ V}, V_{EB(OFF)} = 3.0$		20	nA
	l.	32			
ON CHAR	ACTERISTICS				
h _{FE}	DC Current Gain	$I_C = 0.1 \text{ mA}, V_{CE} = 10 \text{ V}$	35		
		$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$	50		
		$I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}$	75	000	
		$I_{\rm C} = 150 \text{ mA}, V_{\rm CE} = 10 \text{ V}$	100	300	
		$I_C = 150 \text{ mA}, V_{CE} = 1.0 \text{ V}$	50		
.,	Oallantes Facilian Oatsmatics Maltanat	$I_C = 500 \text{ mA}, V_{CE} = 10 \text{ V}$	40	0.0	
V _{CE(sat)}	Collector-Emitter Saturation Voltage*	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.3 1.0	V
V _{BE(sat)}	Base-Emitter Saturation Voltage*	$I_C = 150 \text{ mA}, I_B = 1.0 \text{ mA}$	0.6	1.2	V
V BE(Sat)		$I_C = 500 \text{ mA}, I_B = 5.0 \text{ mA}$	0.0	2.0	V
SMALL SI	GNAL CHARACTERISTICS				
	Output Capacitance	V _{CB} = 10 V, I _E = 0, f = 100 kHz	ĺ	8.0	pF
C _{obo}	· · ·			25	
Cibo	Input Capacitance	$V_{EB} = 0.5 \text{ V}, I_{C} = 0, f = 100 \text{ kHz}$			pF
h _{fe}	Small-Signal Current Gain	$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$ $I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	50 75	300 375	
rb'C _C	Collector Base Time Constant	$I_E = 20 \text{ mA}, V_{CB} = 20 \text{ V}, f = 1.0 \text{ kHz}$	73	150	PS
NF	Noise Figure	$I_C = 100 \mu\text{A}, V_{CE} = 10 \text{V}, R_S = 1.0 \text{k}\Omega$		4.0	dB
	110,00 1 iguio	$f = 1.0 \text{ kHz}, V_{CE} = 1.0 \text{ kHz}$		1.0	4.5
Re(h _{ie})	Real Part of Common-Emitter	$I_C = 20 \text{ mA}, V_{CE} = 20 \text{ V},$		60	Ω
	High Frequency Input Impedance	f = 300 MHz			
CVA/ITCLIN	IC CHARACTERISTICS				
	NG CHARACTERISTICS	IV 20VV 25V		10	
t _d	Delay Time	$V_{CC} = 30 \text{ V}, V_{BE(OFF)} = 0.5 \text{ V},$		10	ns
t _r	Rise Time	$I_C = 150 \text{ mA}, I_{B1} = 15 \text{ mA}$		25	ns
t _s	Storage Time Fall Time	$V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA},$ $I_{B1} = I_{B2} = 15 \text{ mA}$		225	ns

^{*}Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

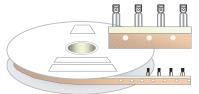


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TO-226AE Tape and Reel Data, continued

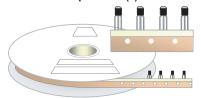
TO-226AE Reeling Style Configuration: Figure 2.0

Machine Option "A" (H)



Style "A" D26Z, D70Z (s/h)

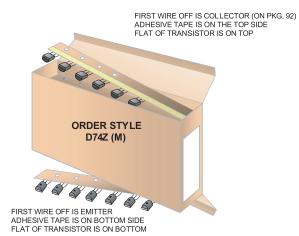
Machine Option "E"(J)



Style "E" D27Z, D71Z (s/h)

TO-226AE Radial Ammo Packaging

Configuration: Figure 3.0

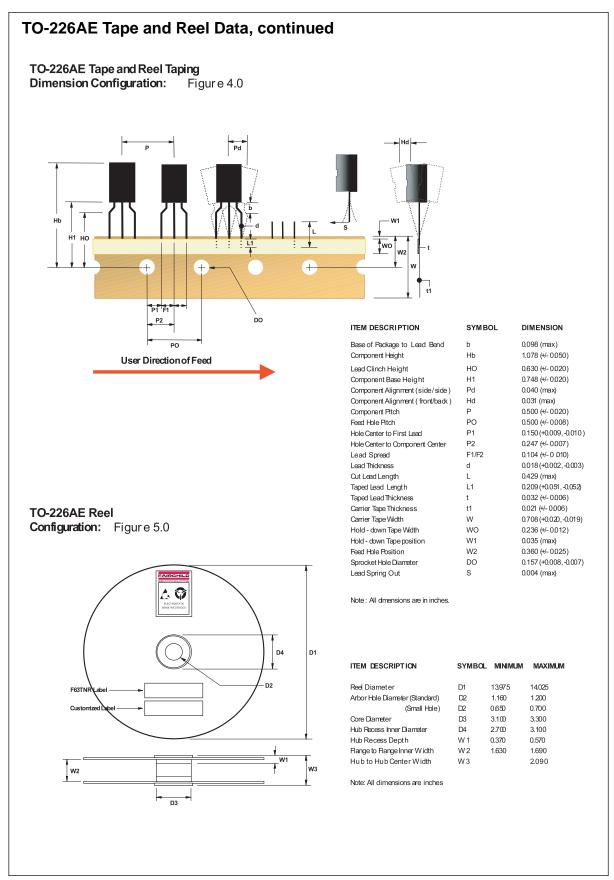


FIRST WIRE OFF IS EMITTER (ON PKG. 92)
ADHESIVE TAPE IS ON THE TOP SIDE
FLAT OF TRANSISTOR IS ON BOTTOM

ORDER STYLE
D75Z (P)

FIRST WIRE OFF IS COLLECTOR ADHESIVE TAPE IS ON BOTTOM SIDE FLAT OF TRANSISTOR IS ON TOP

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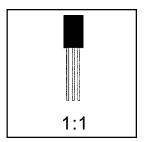
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TO-226AE Package Dimensions



TO-226AE (FS PKG Code 95, 99)

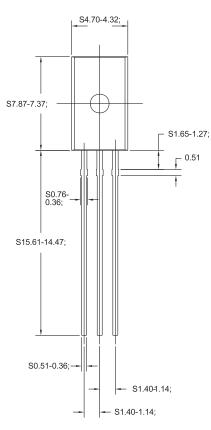


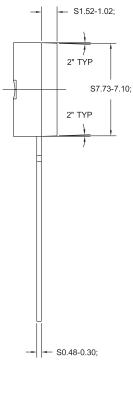


Scale 1:1 on letter size paper

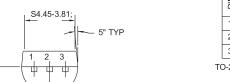
Dimensions shown below are in: inches [millimeters]

Part Weight per unit (gram): 0.300









For leadformed option ordering, refer to Tape & Reel data information.

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